

**McDERMOTT, WILL & EMERY**

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10643980

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**FACSIMILE****Date:** May 21, 2004**Time Sent:****TO:**

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**FROM:** Michael E. Fogarty **Direct Phone:** (202) 756-8372**E-Mail:** mfogarty@MWE.com**Sent By:** Rosanna Pase **Direct Phone:** (202) 756 8392**Client/Matter/Tkpr:** 60188-635-3328 **Original Follow by Mail:****Number of Pages, Including Cover:** 5**MESSAGE:**

Re: U.S. Patent Application Serial No.: 10/643,980  
Inventors: Shuji Hirao, et al.  
Our Reference: 60188-635

As requested in your telephone message to Michael E. Fogarty, enclosed is a complete copy of the Combined Declaration/Power of Attorney filed with the U.S. Patent and Trademark Office on August 20, 2003 in the above-identified application.

The information contained in this facsimile message is legally privileged and confidential information intended only for the use of the individual or entity named above. If the reader of this message is not the intended recipient, you are hereby notified that any dissemination, distribution, or copy of this facsimile is strictly prohibited. If you have received this facsimile in error, please notify us immediately by telephone and return the original message to us at the above address by mail. Thank you.

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03914 U.S. PTO

10/643980



08/20/03

Applicant: Shuji HIRAO, et al.

Docket No. 60188-635

Title: PRODUCTION METHOD OF SEMICONDUCTOR DEVICE  
8/20/2003

Serial No. NOT YET ASSIGNED

Data Sent: ☒ Hand Carried ☐ Fax ☐ Electronic ☐ Cert. of Mailing ☐ Express Mail No.☒ Transmittal LetterNew Patent App ☒ Utility ☐ Design ☐ Cont. ☐ CJP ☐ Div. ☐ PCT ☐ RCE ☐ Prov☐ Other:

22 pages of Specification

5 pages of Claims

1 pages of Abstract

6 pages of Formal Drawings

☐ Small Entity ☒ Large Entity☒ Declaration/Power of Attorney☒ Recordation of Assignment☒ Information Disclosure Statement

1 Form PTO 1449

1 copies of cited references

☐ Preliminary Amendment☐ Response to Missing Parts Notice☐ Resp. to Notice to Correct App. Papers☒ Certified Copy of Priority Doc.☒ Claim for Convention Priority☐ Response/Amendment to Office Action of☐ Request for month Extension of Time☐ Letter submitting pages of drawings☐ Req. for Approval of Drawing Amendments☐ Req. for Oral Hearing☐ Not. of Appeal ☐ Appeal Brief ☐ Reply Brief☐ Rule 312 Amendment/Letter☐ Req. for Acknowledgement of Cited Art☐ Issue Fee☐ Publication Fee☐ Req. for Certificate of Correction☐ Maintenance Fee for years after grant☐ Fee Address Indication Form☐ Terminal Disclaimer☐ Petition to Commissioner☐ Status Inquiry☒ Other Associate Power of Attorney

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EARLY SERIAL NUMBER

THE PATENT AND TRADEMARK OFFICE DATE STAMPED HEREON IS ACKNOWLEDGEMENT THAT THE ITEMS CHECKED ABOVE WERE RECEIVED BY THE PTO ON THE DATE STAMPED



1403-2-20001

Docket No. \_\_\_\_\_

**COMBINED DECLARATION/POWER OF ATTORNEY**  
**FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

**PRODUCTION METHOD OF SEMICONDUCTOR DEVICE**

\_\_\_\_\_, the specification of which

(check one)   X   is attached hereto.

\_\_\_\_\_ was filed on \_\_\_\_\_ as  
Application Serial No. \_\_\_\_\_

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed
<u>2002-245509</u> (Number)	<u>JAPAN</u> (Country)	<u>26/08/2002</u> (Day/Month/Year Filed)	<u>  X  </u> Yes <u>  </u> No
<u>                    </u> (Number)	<u>                    </u> (Country)	<u>                    </u> (Day/Month/Year Filed)	<u>  </u> Yes <u>  </u> No
<u>                    </u> (Number)	<u>                    </u> (Country)	<u>                    </u> (Day/Month/Year Filed)	<u>  </u> Yes <u>  </u> No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:



(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
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(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
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I hereby appoint as my attorneys, with full power of substitution and revocation, to prosecute the patent application identified above and to transact all business in the U.S. Patent and Trademark Office connected therewith: Raphael V. Lupo (Reg. No. 28,363); Jack Q. Lever, Jr. (Reg. No. 28,149); Kenneth L. Cage (Reg. No. 26,151); Stanislaus Aksman (Reg. No. 28,562); Paul Devinsky (Reg. No. 28,553); Edward E. Kubasiewicz (Reg. No. 30,020); Michael E. Fogarty (Reg. No. 36,139); Brian E. Ferguson (Reg. No. 36,801); Robert W. Zelnick (Reg. No. 36,976); and Wilhlem F. Gadiano (Reg. No. 37,136).

Please address all correspondence and telephone calls to:

Jack Q. Lever, Jr.  
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The undersigned hereby authorizes the U.S. attorneys named herein to accept and follow instructions from Maeda Patent Office as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney and the undersigned. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by the undersigned.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Shuji HIRAO

Inventor's signature Shuji Hiraio Date August 8, 2003

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Inventor's signature Takeshi Harada Date August 8, 2003  
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Inventor's signature Kazushi Nii Date August 8, 2003  
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Inventor's signature Kazunori Tsuji Date August 8, 2003  
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